Atty Docket No.: 256502US2SX	(, NOV 3 0 2004 E
FORM PTO-1595 (( 30/0 ×	U.S. DEPARTMENT OF COMMERC Patent and Trademark Off
To the Director of the United States	3-2004 the attached original documents or copy thereof.
1. Name of conveying party(ies):	id address of receiving party(ies):
Kazuhiro TOMIOKA 1029	01951 Name: KABUSHIKI KAISHA TOSHIBA
Haoren ZHUANG	Address: 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan
Additional name(s) of conveying party(ies) attached?	_
3. Nature of Conveyance:	
■ Assignment	
☐ Security Agreement ☐ Change of Name ☐ Other	
Execution Date: November 24, 17, 2004	Additional name(s) and address(es) attached?   Yes  No
4. Application number(s) or patent number(s):	
☐ This document is being filed together with a new	pplication
A. Patent Application No.(s) 10/886,668	B. Patent No.(s)
Additional n	umbers attached?   Yes No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total applications and patents involved: 1
Customer Number	7. Total fee (37 CFR 3.41): \$40.00
22850	Enclosed
Tel. (703) 413-3000	Authorized to be charged to deposit account  8. Deposit account number: 15-0030
Fax. (703) 413-2220	(Attach duplicate copy of this page if paying by deposit account)
DO	NOT USE THIS SPACE
9. Statement and signature	
To the best of my knowledge and belief, the foregoin copy of the original document.	g information is true and correct and any attached copy is a true
Eckhard H. Kuesters	es Reslette fr. Nov 30, 2004
Name of Person Signing	Signature Date
D 1 1 1 1 1 00 000	Joseph Scafetta, Jr.
, n	egistration No. 26,803 ages including this cover sheet: 5
7000 2000	
D	o not detach this portion
Mail documents to be recorded with required cover sh	eet information to:
Director of the Uni Mail Stop A	ted States Patent and Trademark Office Assignment Recordation Services Avandria, Virginia. 22313
Ale	
01/2004 ZJUHAR1 00000030 10886668	
FC:8021 40.00 OP	

In consideration of value received, I, having a residence as stated below above my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

## METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE

sell and assign to

- 1. KABUSHIKI KAISHA TOSHIBA, a Japanese corporation, having a business address at 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan; and
- 2. Infineon Technologies AG, a German corporation, having a business address at St. Martin-Str. 53, 81669, Munich, Germany

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

(check one)	[X]	executed concurr				
		executed on		•		
	[x]	Application No.	10/886,668	, filed	July 9, 2004	

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Oblon, Spivak, McClelland, Maier & Neustadt, P.C., 1940 Duke Street, Alexandria, VA 22314

[1st Inventor]

Residence Address: Yokohama-shi, Japan

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,

Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

Cazuhiro Tomioka

nounder 24, 2004

[2nd Inventor]

Residence Address:

24 Logansway Hopewell Junction NY 12533

Mailing Address:

ICIS Alliance B 300 3G10-34 2070 Route 52 Z32A Hopewell Junction NY 12533

Citizenship: P.R. China

Haoren Zhuang

Date:

In consideration of value received, I, having a residence as stated below above my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

## METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE

sell and assign to

- 1. KABUSHIKI KAISHA TOSHIBA, a Japanese corporation, having a business address at 1·1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan; and
- 2. Infineon Technologies AG, a German corporation, having a business address at St. Martin Str. 53, 81669, Munich, Germany

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

(check one)	[X]	executed concurrently herewith				
		executed on	-	;		
	[x]	Application No. 10	0/886,668	, filed	July 9,	2004

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Oblon, Spivak, McClelland, Maier & Neustadt, P.C., 1940 Duke Street, Alexandria, VA 22314

## ASSIGNMENT

[lst Inventor]

Residence Address: Yokohama-shi, Japan

**RECORDED: 11/30/2004** 

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,

Minato-ku, Tokyo 105-8001, Japan

Citizenship: Japan

Date: Kazuhiro Tomioka

[2nd Inventor]
Residence Address: 24 Logans Way Hopewall Junction Ny 12533
Mailing Address: 1CIS Alliance B300 36/0-34 do 70 Route 52 2524 Hopewall Tunctor
Office BB China

Citizenship: P.R. China

11-17-2000